

The EL325 is a GaAs IRED mounted in a low profile clear epoxy package. This IRED is both compact and easy to mount.

### FEATURES

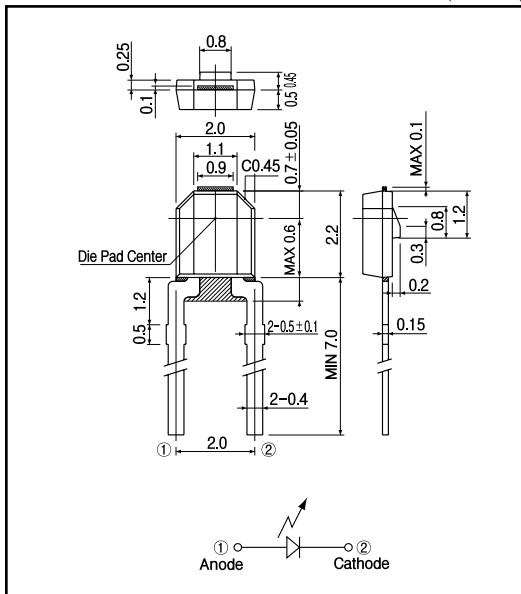
- Ultra compact
- Low profile
- Snap-in mount is possible

### APPLICATIONS

- Photointerrupters
- Optical equipment

### DIMENSIONS

(Unit : mm)



### MAXIMUM RATINGS

(Ta=25 °C)

Item	Symbol	Rating	Unit
Reverse voltage	V <sub>R</sub>	5	V
Forward current	I <sub>F</sub>	50	mA
Power dissipation	P <sub>D</sub>	100	mW
Pulse forward current <sup>*1</sup>	I <sub>FP</sub>	0.5	A
Operating temp.	Topr.	-25 +85	
Storage temp.	Tstg.	-30 +85	
Soldering temp. <sup>*2</sup>	Tsol.	260	

\*1. pulse width : tw 100 μsec. period : T=10msec.

\*2. For MAX.5 seconds at the position of 2 mm from the package

### ELECTRO-OPTICAL CHARACTERISTICS

(Ta=25 °C)

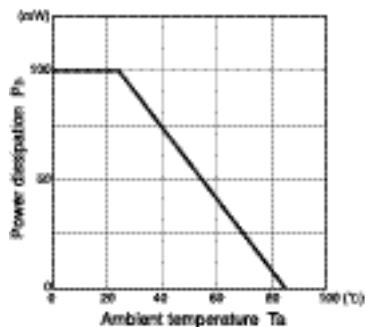
Item	Symbol	Conditions	Min.	Typ.	Max.	Unit.
Forward voltage	V <sub>F</sub>	I <sub>F</sub> =50mA			1.6	V
Reverse current	I <sub>R</sub>	V <sub>R</sub> =5V			10	μA
Peak emission wavelength	λ <sub>p</sub>	I <sub>F</sub> =50mA	940			nm
Spectral bandwidth		I <sub>F</sub> =50mA		50		nm
Radiant intensity <sup>*3</sup>	P <sub>O</sub>	I <sub>F</sub> =50mA	0.7			mW/sr
Half angle				±50		deg.

\*3. Measured by tester of KODENSHI CORP.

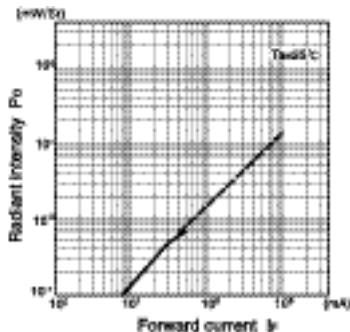
## Infrared Emitting Diodes(GaAs)

EL325

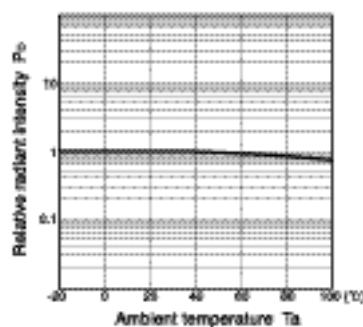
**Power dissipation Vs.  
Ambient temperature**



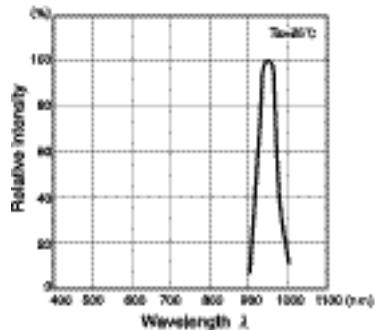
**Radiant intensity Vs.  
Forward current**



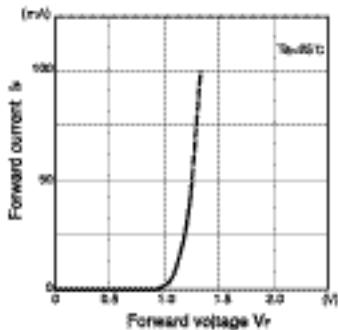
**Relative radiant intensity Vs.  
Ambient temperature**



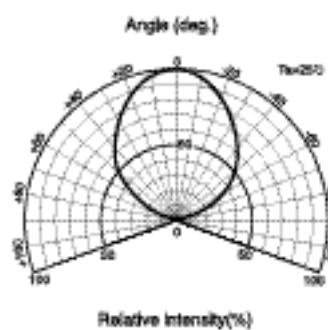
**Relative intensity Vs.  
Wavelength**



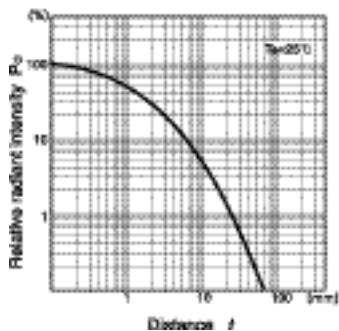
**Forward current vs.  
Forward voltage**



**Radiant Pattern**



**Relative radiant intensity Vs.  
Distance**



Relative radiant intensity Vs.  
Distance test method

